

# Inspur Server NF5260M6 User Manual

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Technical Service Hotline: 1-844-860-0011/1-760-769-1847

No. 1036 Langchao Road, Jinan, PRC

Address:

Inspur Electronic Information Industry Co., Ltd.

Postal Code: 250101

Email: <u>serversupport@inspur.com</u>

## **Abstract**

This manual describes NF5260M6 server's specifications, features, hardware setup, warranty information and troubleshooting, which will help users to understand how best to utilize the server and all its functionalities.

# Target Audience

This manual is intended for:

- Technical support engineers
- Product maintenance engineers

It is recommended that server installation, configuration, and maintenance is performed by experienced technicians only.

## **Safety Precautions**

- If your purchases do not include Inspur on-site installation service, make sure that you inspect the shipping cartons before unpacking the equipment. If a shipping carton appears severely damaged, water immersed, or the seal or pressure-sensitive adhesive tape (PSA) is broken, report this based on your purchase channel. If you purchased from a third-party supplier, contact your supplier directly; if you purchased through Inspur direct sales stores, call Inspur service hotline 1-844-860-0011/1-760-769-1847 for technical support.
- For your safety, please do not disassemble the server's components, extend configuration or connect other peripherals arbitrarily. You can contact Inspur for our support and guidance.
- Before disassembling the server's components, please be sure to disconnect all the cables connected to the server.
- Please install the product-compatible operating system and use the driver that
  comes with the server or provided by Inspur. You can go to our official site, on the
  Top Navigator, click on Support > Product Support > Drivers, then find the correct
  driver of your product based on the prompt. An incompatible operating system or
  a non-Inspur driver may cause compatibility issues and affect the normal use of
  the product. Inspur will not assume any responsibility or liability for this.
- BIOS and BMC setup is a significant factor in correctly configuring your server. If there are no special requirements, it is suggested to use the Default Values and

not alter the parameter settings arbitrarily. After the first login, please change the BMC user password in time.

## Conventions

The symbols that may be found in this document are defined as follows.

Symbol	Description
DANGER	A potential for serious injury, or even death if not properly handled
WARNING	A potential for minor or moderate injury if not properly handled
CAUTION	A potential loss of data or damage to equipment if not properly handled
(i) IMPORTANT	Operations or information that requires special attention to ensure successful installation or configuration
NOTE	Supplementary description of important information

# **Revision History**

Version	Date	Description of Changes
V1.0	2021/06/20	Initial release
V1.1	2021/09/22	Added ErP Lot 9 tables

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# 1 Safety Instructions

## 1.1 Warnings

Please be advised to follow the instructions below for safety. Failure to do so could result in potential dangers that may cause property loss, personal injury or death.

- The power supplies in the system may produce high voltages and energy hazards that may cause personal injury. For your safety, please do not attempt to remove the cover of the system to dissemble or replace any component on your own. Unless informed by Inspur, only service technicians trained by Inspur are authorized to do so.
- Please connect the equipment to an appropriate power supply. Use only the external power supplies indicated on the rated input label to power the system. To protect your equipment from damages caused by a momentary spike or plunge of the voltage, please use voltage stabilizing equipment or uninterruptible power supplies.
- Do not connect two or more power cords to each other. If a longer power cord is needed, contact Inspur Customer Service.
- Please be sure to use the power supply components that come with the server, such as power cords, power socket (if provided with the server) etc. For your safety and safety of the equipment, please do not replace power cords or plugs randomly.
- To prevent electric shocks caused by leakage in the system, please make sure that the power cables of the system and peripherals are correctly connected to the earthed/grounded outlet. Please connect the three-core power plug to the three-core AC power outlet that is well earthed and within reach. Be sure to use the earthing/grounding pin of power cord and do not use the patch plug or the earthing/grounding pin unplugged with cables. In the case that the earthing/grounding conductors are not installed and it is uncertain whether there is appropriate earthing/grounding protection, please do not use or attempt to operate the equipment. You can contact and consult an electrician.
- Please do not push any objects into the openings of the system. Doing so may cause short circuit of internal components and then lead to fire or electric shock.
- Please keep the system far away from the heatsink and heat sources, and be sure not to block the air vents.
- Please be sure not to scatter food or spill liquid into the system or onto other components. Do not use the product in high humid or dusty environments.

- Using an incompatible battery may cause explosion. When battery replacement is required, please consult the manufacturer first, and choose batteries of the same or equivalent type suggested by them. Do not disassemble, crush, puncture the batteries or short circuit the external connection point, and do not expose them in the environment over 60°C (140°F). Never throw batteries into fire or water. Please do not attempt to open or repair the batteries. Dispose of used batteries properly. Do not put waste batteries, circuit boards or other components that may contain batteries with other wastes. For battery recycling, please contact the local waste recycling center.
- For independent cabinets, please install front and side stabilizers before installing the equipment into the cabinet. For cabinets connected with other cabinets, please install front stabilizers first. Failure to install the corresponding stabilizers before installing the equipment into the cabinet may cause the cabinet to tip over, possibly leading to personal injury. Hence, please do make sure to install stabilizers before installing the equipment into the cabinet. After installing the equipment and other components into the cabinet, only one component can be pulled out from the cabinet through its sliding part at one time. Pulling out several components at the same time may cause the cabinet to turn over, resulting in serious personal injury.
- Please do not move the cabinet on your own. Considering the height and weight of the cabinet, the moving of the cabinet should be completed by at least two people. Moving it without adequate, trained personnel could result in severe injury or death.
- It is prohibited to directly short-circuit the copper busbar. Please do not touch the copper busbar when the cabinet is powered on.
- This is a Class A product, and may cause radio interference. In such case, users may need to take necessary measures to mitigate the interference.

#### 1.2 Precautions

The following considerations may help avoid problems that could damage the components or cause data loss, etc.

- In the event of the following, please unplug the power plug from the outlet and contact Inspur Customer Service:
  - The power cords or power plugs are damaged.
  - The products get wet.
  - The products have fallen or have been damaged.
  - Other objects have fallen into the products.

- The products do not or cannot function normally even when you operate according to the instructions.
- If the system gets wet or damp, please follow steps below:
  - a. Power off the equipment, disconnect them with the outlet, wait for 10 to 20 seconds, and then open the access panel.
  - b. Move the equipment to a well-ventilated place to dry the system for at least 24 hours and make sure that the system is fully dried.
  - c. Close the access panel, reconnect the system to the power outlet, and then power on.
  - d. In case of operation failure or other abnormal situations, please contact Inspur for technical support.
- Avoid cabling system cables and power cords in high foot traffic locations.
   Please do not place objects on the cables.
- Before removing the access panel or accessing the internal components, please let the equipment cool first. To avoid damaging the motherboard, please power off the system and wait for 5 seconds, and then remove components from the motherboard or disconnect the peripherals from the system.
- If there are modem, telecom or LAN options installed in the equipment, please pay attention to the followings:
  - In case of lightning, please do not connect or use the modem. Otherwise, there's risk of lightning stroke.
  - Never connect or use the modem in a damp environment.
  - Never insert the modem or telephone cables into the socket of network interface controller (NIC).
  - Before unpacking the product package, accessing or installing internal components, or touching uninsulated cables or jacks of the modem, please disconnect the modem cables.
- In order to avoid damages of electronic components in the equipment caused by electrostatic discharge, please pay attention to the followings:
  - Please remove any static electricity on your body before dismounting or accessing any electronic component in the equipment, to prevent the static electricity from conducting itself to the sensitive components. You may remove the static electricity on your body by touching the metal earthing objects (such as the unpainted metal surface on the rack).
  - Please do not take static sensitive components that are not ready to be installed or used out of the anti-static packages.

- During operation, please touch the earthing conductor or the unpainted metal surface on the cabinet regularly to remove any static electricity from your body that may damage the internal components.
- When dismounting internal components upon receiving proper authorization from Inspur, please pay attention to the followings:
  - a. Power off the system and disconnect the cables, including all connections of the system. When disconnecting the cables, please hold the connector of the cables to slowly pull them out. Never pull the cables.
  - b. Only after the products completely cool down can you dismount the access panel or access the internal components.
  - c. Please remove any static electricity on your body by touching metal earthing objects before dismounting or accessing any electronic component in the equipment.
  - d. When dismounting, avoid making large movement to prevent damage to the components or scratching arms.
  - e. Handle components and plug-in cards with care. Please do not touch the components or connectors on the plug-in cards. When handling the plug-in cards or components, firmly grab the edges of the plug-in cards or those of components, or their metal retaining brackets.
- During cabinet installation and application, please pay attention to the followings:
  - After the cabinet has been installed, please ensure that the stabilizer feet have been fixed into the rack and supported to ground, and the full weight of the cabinet is on the ground.
  - Always load from the bottom up, and load the heaviest items first.
  - When pulling out components from the rack, apply slight force to keep the rack balanced.
  - Please be careful when pressing down the release latch to slide components in or out as the rail may hurt your fingers.
  - Do not overload the AC power branch circuits in the cabinet. The total load of the cabinet should not exceed 80% of the ratings of the branch circuits.
  - Ensure that components in the cabinet are well vented.
  - When repairing components in the cabinet, never step on any other component.

# 2 Product Specifications

#### 2.1 Introduction

The main feature of NF5260M6 lies in that all the PCIe interfaces support connection to cables, making it the most flexible system among all Inspur M6 servers. It features two OCP NIC cards that cater the needs of European and American customers. The server maintains high quality and reliability of Inspur servers and achieves innovation and breakthrough in compute performance, scalability, configuration elasticity, intelligent management, etc.

#### Key features:

- Two Intel® Xeon® Scalable Ice Lake Processors with TDP up to 270 W
- 3 channels UPI for 11.2 GT/s
- Up to 32 DDR4 DIMMs with RDIMMs, LRDIMMs and NVDIMMs (only Barlow Pass) supported
- Up to 12 hybrid SAS/SATA/NVMe drives or up to 16 NVMe SSDs or 24 SATA/SAS drives at the front
- Up to four 2.5-inch drives (4 HDDs or 2 HDDs + 2 NVMe SSDs) at the rear
- Two OCP NIC 3.0 cards
- 11 onboard Slimline x8 connectors
- Up to 14 onboard direct-attached drives from PCH
- Up to 4 FHHL PCIe cards (horizontal) or 6 HHHL PCIe cards (vertical)
- Up to 4 single-width GPUs
- Motherboard integrated with AST2500 BMC chip with KVM functionality as standard
- Hot-swap LCD module and remote monitoring on mobile devices via BMC
- Intel remote BMC debug
- Modular design of drives, PCI expansion cards, PSUs and fans, enabling freetool maintenance
- Hot-swap and redundant CRPS of 80 Plus Platinum or higher rank with PMBus and NM 4.0 functionality
- Hot-swap fan/fan cage design; the fan is N+1 redundant and of low noise

## 2.1.1 24 × 2.5-inch Configuration (Full Configuration)

Up to 24 front 2.5-inch SAS/SATA/NVMe drives, as shown in the figure below.

Figure 2-1 24 × 2.5-inch Drive Configuration



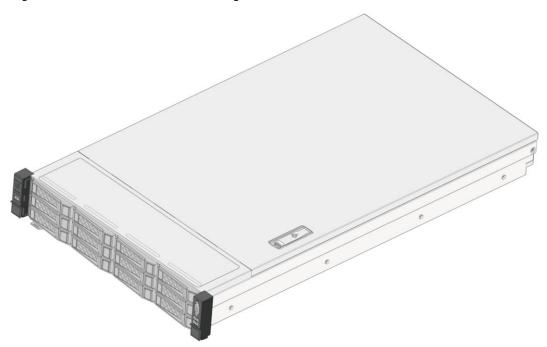
## 2.1.2 12 × 3.5-inch Configuration (Full Configuration)



3.5-inch drive trays can accommodate 3.5- or 2.5-inch drives.

Up to 12 front 3.5/2.5-inch SAS/SATA/NVMe drives, as shown in the figure below.

Figure 2-2 12 × 3.5-inch Drive Configuration



# 2.2 Features and Specifications

Table 2-1 Features and Specifications

Time to Barrier	2021/7				
Time to Market	2021/7				
Processor	Processor				
Processor Type	Intel® Xeon® Scalable Processors (2 CPUs, TDP up to 270				
	W)				
Socket	2				
Chipset					
Chipset Type	C621-A				
Memory					
Memory Type	RDIMMs, LRDIMMs and NVDIMMs (Only Barlow Pass				
	supported)				
Memory Slot Qty	32 (For detailed population guidelines, see DIMM				
	Replacement)				
Total Memory Capacity	Up to 4.0 TB (128 GB per memory module)				
I/O Port					
USB Port	Up to 5 USB 3.0 ports (2 front, 2 rear and 1 onboard)				
Video	1 front VGA port				
	·				
	• 1 rear VGA port				
Serial Port	1 rear serial port				
UID Button with LED	1 UID button with LED on the front panel				

Display Controller				
Controller Type	resolution			
Backplane				
Backplane Hot-swap SAS/SATA/NVMe drives				
NIC	<b>,</b>			
NIC Controller	Standard OCP NIC 3.0 cards or standard PCIe cards on the motherboard			
Management Chip				
Management Chip	Integrated with 1 independent 1000 Mbps network interface, dedicated for IPMI remote management			
PCIe Expansion Slots	4 full-height half-length PCIe x16 plug-ins			
	6 half-height half-length PCIe plug-ins (4 PCIe x16 and 2 PCIe x8 plug-ins)			
	Up to two OCP NIC 3.0 cards			
Drive				
Drive Type	2.5/3.5-inch SAS/SATA/NVMe drives (Actual configuration may vary depending on the model you purchased)			
External Storage Drive	,			
Optical Drive	External USB optical drives			
T-flash Card	NA			
Power				
	Single/dual power supplies with output power at 800 W/1300 W/1600 W/2000 W and above)			
Specifications	• 1+1 redundant			
Specifications	• 2 PSUs			
	PMBus and Node Manager 4.0 functionality supported			
Power Input	Please refer to the power input on the nameplate label of the chassis			
Physical				
Outer Packaging	ging 780-length packaging box: 651 width × 295 height × 1031			
Dimensions				
Chassis Dimensions	• 780-length chassis (without mounting ears): 435 width × 87 height × 779.5 depth (mm)			
C.Id33I3 DIIIICII3IUII3	• 780-length chassis (with mounting ears): 478.8 width × 87 height × 811.7 depth (mm)			

	• 12 × 3.5-inch Configuration (With 12 drives)		
Product Weight	Net weight: 30 kg Gross weight: 40 kg (Chassis + Shipping Carton + Rails + Accessory Box)		
Froduct Weight	• 24 × 2.5-inch Configuration (With 24 drives)		
	Net weight: 24 kg		
	Gross weight: 34 kg (Chassis + Shipping Carton + Rails +		
	Accessory Box)		

# 2.3 Power Efficiency

Table 2-2 Power Efficiency of Platinum Power Supplies

Rated Power	@20% Load	@50% Load	@100% Load	PF@50% Load
800 W	90%	94%	91%	0.98
1300 W	90%	94%	91%	0.98
1600 W	90%	94%	91%	0.98
2000 W	90%	94%	91%	0.98

Table 2-3 ErP Lot 9-1

EU Regulation 2019/424 Server configurations	High-end performance configuration	Low-end performance configuration
(h) idle state power	251.3	186
(i) list of all components for additional idle power allowances, if any (additional PSU, HDDs or SSDs, additional memory, additional buffered DDR channels, additional I/O devices);	394.52	184.39
(j) maximum power, expressed in Watts and rounded to the first decimal place;	601	488.2
(k) declared operating condition class;	A2	A2
(l) idle state power (Watts) at the higher boundary temperature of the declared operating condition class;	216	187

EU Regulation 2019/424 Server configurations	High-end performance configuration	Low-end performance configuration
(m) the active state efficiency and	45.5	28.5
the performance in active state of		
the server;		

Table 2-4 ErP Lot 9-2

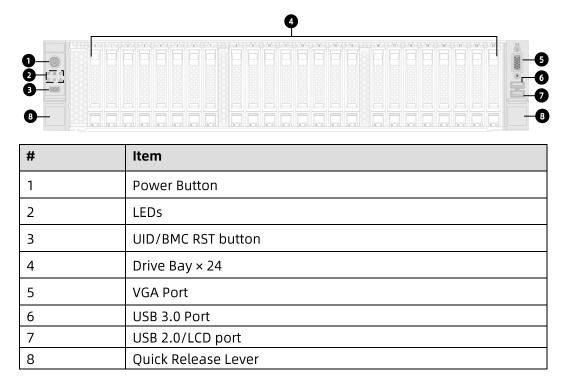
(i) List of components for additional power allowance		High-end performance configuration	Low-end performance configuration
CPU Performance	1 socket: 10 × Perf CPU W 2 socket: 7 × Perf CPU W	150.92	79.03
Additional PSU	10 W per PSU	10	10
HDD or SSD	5.0 W per HDD or SSD	10	10
Additional memory	0.18 W per GB	183.6	45.36
Additional buffered DDR channel	4.0 W per buffered DDR channel	32	32
Additional I/O devices	<1 Gb/s: No Allowance = 1 Gb/s: 2.0 W/Active Port > 1 Gb/s and < 10 Gb/s: 4.0 W/Active Port ≥ 10 Gb/s and < 25Gb/s: 15.0 W/Active Port ≥ 25 Gb/s and < 50Gb/s: 20.0 W/Active Port ≥ 50 Gb/s 26.0 W/Active	8	8
Port     Total additional idle state power allowed		394.52	184.39

## 3 Product Overview

#### 3.1 Front Panel

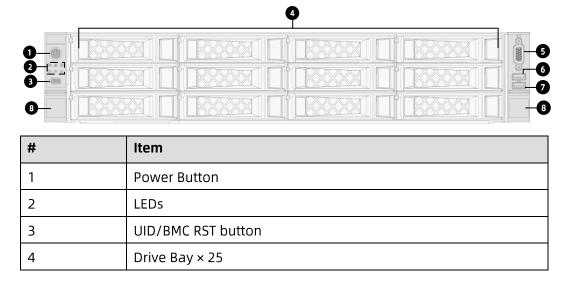
## 3.1.1 $24 \times 2.5$ -inch Drive Configuration

Figure 3-1 Front Panel of 24 × 2.5-inch Drive Configuration



## 3.1.2 $12 \times 3.5$ -inch Drive Configuration

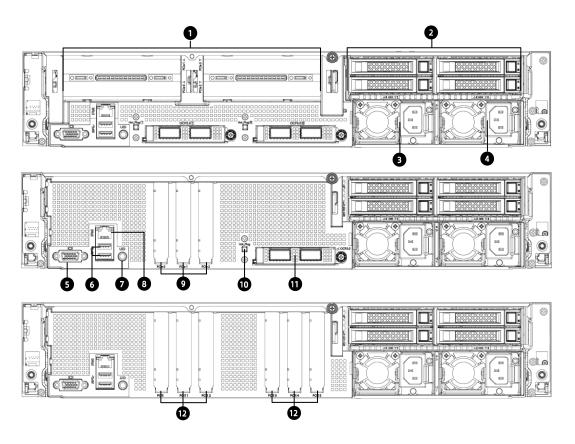
Figure 3-2 Front Panel of 12 × 3.5-inch Drive Configuration



#	Item
5	VGA Port
6	USB 3.0 Port
7	USB 2.0/LCD port
8	Quick Release Lever

## 3.2 Rear Panel

Figure 3-3 Rear Panel



#	Item	#	Item
1	PCIe Expansion Slots	7	UID LED
2	Rear 2.5" Drive Bays	8	MLAN Connector
3	PSU1 Connector	9	PCIe Expansion Slots
4	PSU0 Connector	10	OCP NIC 3.0 Card Power LED
5	VGA Port	11	OCP NIC 3.0 Card Module

#	Item	#	Item
6	USB Ports	12	PCIe Expansion Slots

## 3.3 Buttons and Status LEDs

#### 3.3.1 Front Panel Buttons and LEDs

Table 3-1 Front Panel Buttons and LEDs

#	Icon	Item	Description
1	(1)	Power Button	<ul> <li>Solid green = Power on state</li> <li>Solid orange = Standby state</li> <li>Long press 4 seconds to force a shutdown</li> </ul>
2		System Status LED	<ul> <li>Off = Normal</li> <li>Solid red = A failure occurs</li> <li>Flashing red = A warning occurs</li> </ul>
3	Ш	Memory Status LED	<ul> <li>Off = Normal</li> <li>Solid red = A failure occurs</li> <li>Flashing red = A warning occurs</li> </ul>
4	S	Fan Status LED	<ul> <li>Off = Normal</li> <li>Solid red = Fail to read the fan speed</li> <li>Flashing red = Speed reading is abnormal</li> </ul>
5	4	Power Status LED	<ul> <li>Off = Normal</li> <li>Solid red = A power failure occurs</li> <li>Flashing red = Power state is abnormal</li> </ul>

#	Icon	Item	Description
6	<i>\$</i> }}	System Overheat LED	<ul><li>Off = Normal</li><li>Solid red = CPU/Memory overheats</li></ul>
7	믊	Network Status LED	<ul> <li>Solid/Flashing green =         Network connected</li> <li>Off = No network connection</li> <li>Note: It only indicates the working status of LOM (LAN on motherboard)</li> </ul>
8	UID	UID/BMC RST Button	<ul> <li>Solid blue = UID is turned on manually or in the OS</li> <li>Flashing blue = KVM has been launched or firmware update in process</li> <li>Long press 6 seconds to force BMC to be reset</li> </ul>

## 3.3.2 Drive Tray LEDs

Figure 3-4 Drive Tray LEDs



#	Item	Description
1	Activity Status LED	<ul> <li>Solid green = Normal</li> <li>Flashing green = Read/write activities</li> </ul>
2	Drive Fault LED	<ul> <li>Solid red = Drive error or failed</li> <li>Solid blue = Drive is being located</li> <li>Solid pink = RAID Rebuilding</li> </ul>

#### 3.3.3 **PSU LEDs**

Table 3-2 PSU LEDs

#	PSU LED Status	Description
1	Solid green	Normal
2	Off	No AC power to PSU
3	Solid amber	A shutdown has occurred when the
		protection mechanism had been
		triggered
4	Flashing amber at 1 Hz	PSU continues operating after a
		warning event has occurred
5	Flashing green at 1 Hz	PSU removed from the power bay
		with AC input
6	Flashing green at 0.33 Hz (on for	PSU operates in cold redundant
	2 seconds and off for 1 second)	and sleep mode
7	Flashing green at 2 Hz	PSU operates in firmware update
		mode

## 3.3.4 OCP Hot-Swap Button with LED

Table 3-3 OCP Hot-Swap LED Description

#	LED Status	Description
1	Solid green	Normal
2	Off	OCP NIC is powered off

## 3.4Interface Description

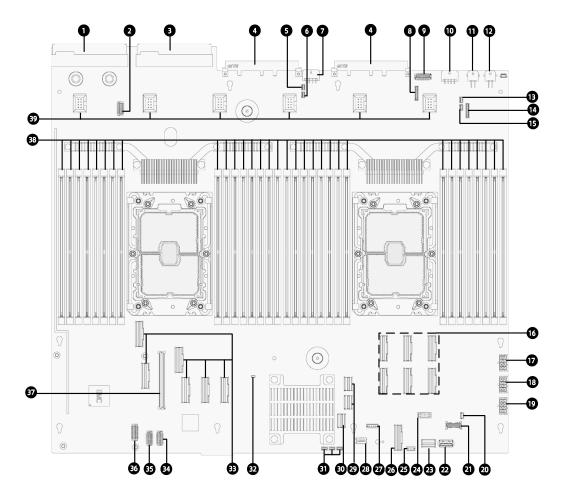
Table 3-4 Interface Description

#	Interface	Function
1	VGA Port	Enables you to connect a display terminal to
ı	VGA POIT	the system
2	LICD 2 O Dort	Enables you to connect a USB device to the
2	USB 3.0 Port	system
2	LICD 2 0 Dort	Enables you to connect a USB device to the
5	USB 2.0 Port	system
4	LICE 2 0/LCD Dort	Enables you to connect a USB device or a LCD
4	USB 2.0/LCD Port	device to the system
	DMC Management	Enables you to manage the server
5	BMC Management	Note: The port is a Gigabit Ethernet port of
	Network Port	100/1000M (self-adaption)

6	OCP Network Port	Enables you to connect an OCP NIC to the system
7	PCIe NIC Ports (Plug-ins)	Enables you to connect to network

## 3.5 Motherboard View

Figure 3-5 Motherboard Connectors



#	Item	#	Item
1	PSU0 Connector	21	Rear IO Board Signal Cable Connector
2	IPMB Connector	22	USB 3.0 Port
3	PSU1 Connector	23	USB Signal Cable Connector

#	Item	#	Item
4	OCP 3.0 Slot × 2	24	CPU_VPP_I2C Signal Cable Connector
5	Rear Drive Backplane 1 I <sup>2</sup> C Signal Connector	25	Intrusion Switch Connector
6	Rear Drive Backplane 0 I <sup>2</sup> C Signal Connector	26	M.2 Riser Card Signal Cable Connector
7	Smart NIC Connector	27	VROC Key Connector
8	Rear Riser Card 1 I <sup>2</sup> C Signal Connector	28	TPM Connector
9	Rear Riser Card 1 Power Connector	29	SATA Signal Connector
10	Rear Riser Card 2 Power Connector	30	sSATA Signal Connector
11	Rear Drive Backplane 0 Power Connector	31	Front Drive Backplane BMC I <sup>2</sup> C Signal Connector
12	Rear Drive Backplane 1 Power Connector	32	CLR_CMOS
13	OCP Card 2 Power LED Connector	33	CPU0 PCIe Signal Slimline Connector
14	Rear Riser Card 2 I <sup>2</sup> C Signal Connector	34	MLAN Signal Connector
15	OCP Card 1 Power LED Connector	35	Front VGA Signal Connector
16	CPU1 PCIe Signal Slimline Connector	36	Front LED/Button Signal Connector
17	Front Drive Backplane 2 Power Connector	37	Onboard RAID Card Slot

#	Item	#	Item
18	Front Drive Backplane 1 Power Connector	38	DIMM Slots
19	Front Drive Backplane 0 Power Connector	39	System Fan 0-5 Connectors
20	Front Temperature Sensor Cable Connector		

## 3.6 Motherboard Jumper Introduction



For your personal safety and protection of the equipment, it is necessary to shut down the system and disconnect the power cables.

See Motherboard View for the jumper location.

Table 3-5 CMOS Jumper Cap

Item	Description		Function
J48 (CLR_CMOS)	CMOS clear jumper	•	Short-circuit pins 1-2 to restore to normal status.
		•	Short-circuit pins 2-3 to clear CMOS.

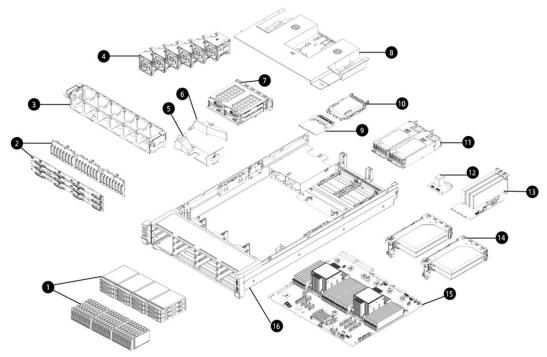
To clear the CMOS setting via a jumper:

- 1. Power down the server and unplug the power cable from the electrical outlet.
- 2. Wait for 5 seconds.
- 3. Locate the CMOS clear jumper on the motherboard.
- 4. Move the jumper cap from the default pins 1-2 to pins 2-3.
- 5. Plug in the power cable and power on the server, and then wait for 10 seconds for the CMOS to clear.

- 6. Power down the server, unplug the power cable, and then wait for 5 seconds again.
- 7. Move the jumper cap back to the default pins 1-2.
- 8. Reconnect the power cable and power on the server.

## 3.7 System Layout

Figure 3-6 Exploded Diagram



#	Item	#	Item
1	Front Drives	9	OCP Card Adapter
2	Front Drive Backplanes	10	OCP NIC Card
3	Fan Cage	11	PSU
4	Fan Modules	12	Rear IO Board
5	Air Duct for PSU	13	Vertical Plug-in Module
6	Air Duct for Rear Drives	14	PCIe Riser Card Assembly
7	Rear Drive Bays	15	Motherboard
8	Air Duct	16	Chassis

# 4 Getting Started

Apply force properly when operating the server. Take a record for complicated operations (such as connecting and disconnecting cables) to reassemble the server.

#### 4.1 Installing Server into the Rack

For detailed information on installing the server into the rack with rails supplied by Inspur, see *Rack-Mounted Server Installation Guide*.



If you would like to use non-Inspur rails, please contact Inspur Customer Service first to ensure the server can be installed to the rack safely and properly. The loading-bearing capacity of non-Inspur rails must be higher than 100 kg. If not, you MUST use Inspur-supplied rails as using these non-Inspur rails may cause such risks as installation failure. Inspur will not assume any responsibility or liability for any damage or injury caused by this.



#### WARNING

To reduce the risk of personal injury or damage to the equipment, DO secure the mounting ears to the posts firmly to avoid server from moving or sliding out from the cabinet.

#### 4.2 Power On/Off

To power on and off the server, press the Power button.

To completely shut down the server, press the **Power** button and disconnect the power cable from the server.



#### DANGER

To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to disconnect power from the server. The Power button does not shut off the system power completely. Portions of the power supply and some internal circuitry remain active until the AC power is removed.

## 4.3 Pre-Disassembly Instructions

Read the installation instructions for all the hardware operations before disassembling or re-assembling the components. All prerequisites must be completed prior to starting installation or maintenance.



## NARNING

To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching.



#### CAUTION

To prevent damage to electrical components, properly ground the server before installation. Improper grounding can cause electrostatic discharge.

Do the following prior to starting installation or maintenance:

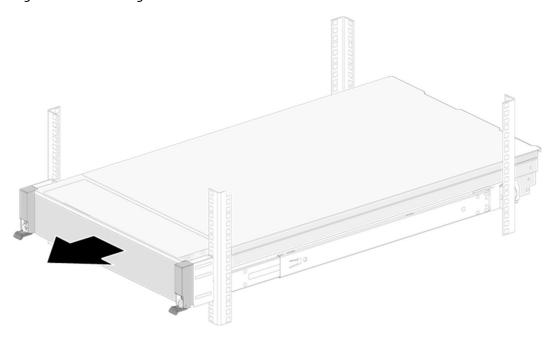
- 1. Power down the server.
- 2. Remove all cables from the server.



#### WARNING

- To reduce the risk of personal injury or equipment damage, be sure that the rack is adequately stabilized before you extend a component from the rack.
- To reduce the risk of personal injury, be careful when sliding the server into the rack. The sliding rails could pinch your fingers.
- 3. Open both quick release levers on the front panel of the server, and then loosen the two captive screws securing the server in place.
- 4. Gently slide and remove the server out of the rack.

Figure 4-1 Removing the Server from the Rack





- After performing installation or maintenance, slide the server all the way back into the rack to secure it in place.
- For more information on how to install the server into the rack, refer to Rack-Mounted Server Installation Guide.

#### 4.4 Disassembly/Reassembly Process



- During installation or removal of any hardware, always ensure all data is backed up properly.
- Disconnect the server and all attached devices from their electrical outlets.
- There is no need to remove power from the server when replacing hot-swap components.
- If more than one option is to be installed, read the installation instructions for all the hardware options and identify similar steps to streamline the installation process.

Item appearance may be different on actual models.

#### 4.4.1 Access Panel Replacement



To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching.

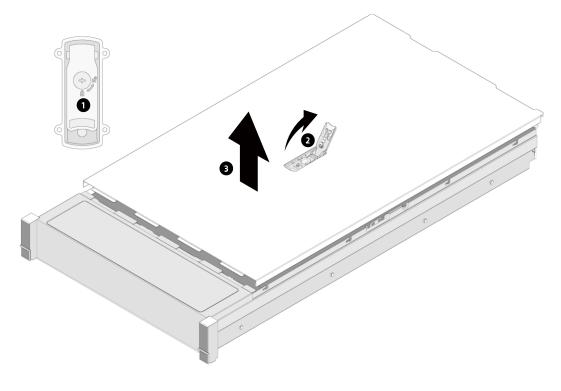


- For proper cooling, do not operate the server without the access panel, air duct, or fans installed.
- If the server supports hot-swap components, minimize the amount of time the access panel is open.

#### To remove the access panel:

- 1. Loosen the security screw on the hood latch anticlockwise to the unlocked position with a Phillips screwdriver.
- 2. Lift up the hood latch handle until the access panel slides back and the tabs on the access panel disengage from the guide slots on the chassis. Hold the access panel on both sides and remove the panel away from the server.

Figure 4-2 Removing the Access Panel



To install the access panel:

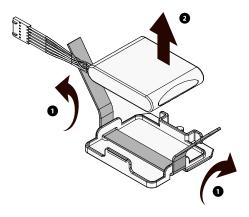
- 1. Open the hood latch handle, align the standoffs of the access panel with the J-slots on the chassis. Lower the access panel down onto the chassis.
- 2. Press down the hood latch and then slide the access panel toward the front of the server until the tabs on the access panel engage with the guide slots on the chassis, and the hood latch locks into place.
- 3. Tighten the security screw on the hood latch clockwise with a Phillips screwdriver to the locked position.

#### 4.4.2 Super-Capacitor Replacement

To remove the super-capacitor:

- 1. Remove the access panel.
- 2. Disconnect the cables of the super-capacitor.
- 3. Undo the velcro of the super-capacitor.
- 4. Remove and put the super-capacitor into an antistatic bag.

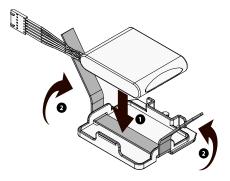
Figure 4-3 Removing the Super-Capacitor



To install the super-capacitor:

- 1. Take the new super-capacitor out from the antistatic bag and position it in place.
- 2. Secure the super-capacitor in place with velcro.

Figure 4-4 Installing the Super-Capacitor



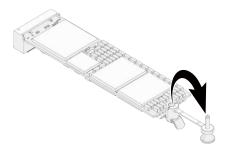
- 3. Connect the cable of the super-capacitor.
- 4. Install the access panel.

#### 4.4.3 M.2 SSD Replacement

To remove the M.2 SSD:

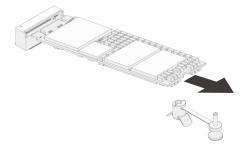
- 1. Remove the access panel.
- 2. Open the latch securing M.2 SSD in place, and one side of the SSD pops up.

Figure 4-5 Opening the Latch of M.2 SSD



3. Tilt and pull out the M.2 SSD. Put it into an antistatic bag.

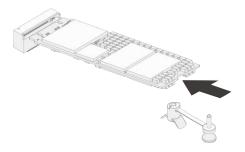
Figure 4-6 Removing the M.2 SSD



To install the M.2 SSD:

- 1. Take the new M.2 SSD out from the antistatic bag.
- 2. Tilt the M.2 SSD a little and insert it into the slot.

Figure 4-7 Installing the M.2 SSD



3. Secure the M.2 SSD onto the board with the latch.

Figure 4-8 Installing the M.2 SSD Latch



#### 4.4.4 Air Duct Replacement

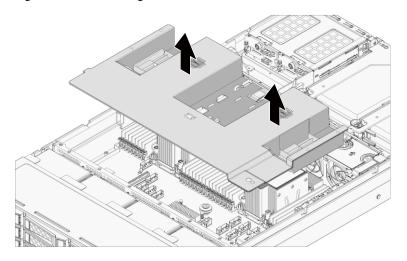


- For proper cooling, do not operate the server without the access panel, air ducts, expansion slot covers, or blanks installed.
- If the server supports hot-swap components, minimize the amount of time the access panel is open.

#### To remove the air duct:

- 1. Remove the access panel.
- 2. Remove the super-capacitor on the air duct.
- 3. Remove the M.2 board.
- 4. Hold the air duct with two hands to remove it.

Figure 4-9 Removing the Air Duct



#### To install the air duct:

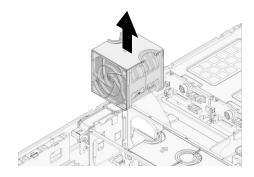
- 1. Lower down the air duct vertically into the chassis.
- 2. Install the super-capacitor.
- 3. Install the M.2 board.
- 4. Install the access panel.

#### 4.4.5 Hot-Swap Fan Module Replacement

#### To remove the fan module:

- 1. Remove the access panel.
- 2. Remove the fan module:
  - a. Squeeze the circular release tabs towards each other, and then lift up the fan module out of the fan bay.
  - b. Put the fan module in an antistatic bag.

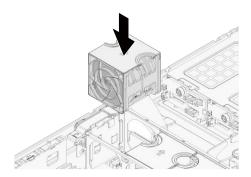
Figure 4-10 Removing the Fan Module



To install the fan module:

- 1. Take the new fan module out from the antistatic bag.
- 2. Align the fan power connector with the power connector on the motherboard and install the fan module vertically to the motherboard.

Figure 4-11 Installing the Fan Module



- 3. Install the access panel.
- 4. Verify that the fan status LED is off.

### 4.4.6 DIMM Replacement



- Mixing use of RDIMMs and LRDIMMs is not allowed.
- Mixing use of BPS is not allowed.
- Mixing use of BPS with RDIMMs or LRDIMMs is allowed.

#### To remove the DIMM:

- 1. Remove the access panel.
- 2. Disconnect the cables connected to the super-capacitor and M.2 board.
- 3. Remove the air duct.
- 4. Locate the DIMM you want to replace.

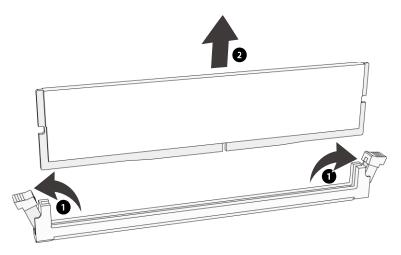
#### To remove the DIMM:

a. Push the release tabs outwards on both ends of the DIMM slot to unlock it. Gently lift and remove the DIMM from the slot.



Make sure the release tabs on both ends of the DIMM slot are fully opened.

Figure 4-12 Removing the DIMM

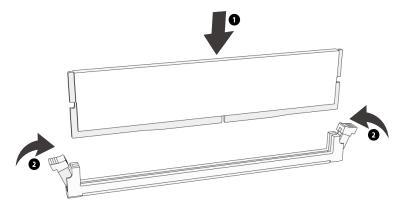


b. Put it into the memory box.

#### To install the DIMM:

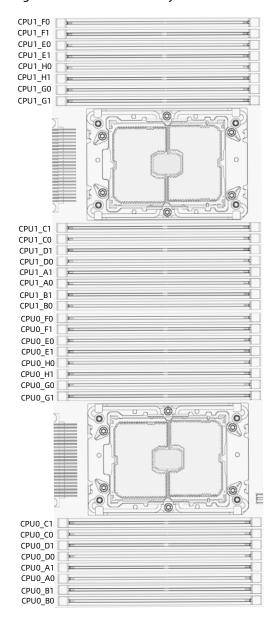
- 1. Take the new DIMM out from the memory box.
- 2. Align the bottom notch with the receptive point on the slot. Use two thumbs together to press both ends of the module straight down into the slot until the module snaps into place.

Figure 4-13 Installing the DIMM



- 3. Install the air duct.
- 4. Connect the cables of the super-capacitor and M.2 board.
- 5. Install the access panel.

Figure 4-14 DIMM Slot Layout



Detailed DIMM population and combination principles are as follows:

Table 4-1 DIMM Population Sequence for 2-CPU Configuration

DDR4		CPU0					CPU1																									
Qty	Α0	Α1	во	В1	CO	<b>C</b> 1	D0	D1	EO	E1	F0	F1	G0	G1	но	Н1	Α0	Α1	во	В1	CO	<b>C1</b>	D0	D1	EO	E1	FO	F1	G0	G1	но	Н1
1	v																															
2	v																v															
4	v								v								v								v							
8	v				v				v				v				v				v				v				v			
12	v		٧		v				v		v		v				v		v		v				v		v		v			
16	v		V		v		v		v		v		v		v		v		v		v		v		v		v		v		v	
24	v	V	V	v	v	v			v	v	v	v	v	v			v	v	v	v	v	v			v	v	v	v	v	v		
32	v	V	v	v	v	v	v	v	v	v	v	v	v	v	v	v	V	v	v	v	v	v	v	v	v	v	v	v	v	v	v	v

# 4.4.7 Processor and Heatsink Module (PHM) Replacement

The server supports dual-processor configuration depending on the model you purchased.



#### CAUTION

- To help avoid damage to the processor and motherboard, do not install the processor without using the processor installation tool.
- To prevent possible server malfunction and damage to the equipment, multiprocessor configurations must contain processors with the same part number.

#### To remove the PHM:

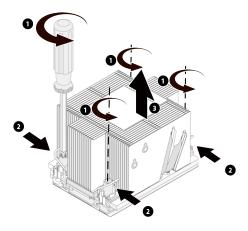


#### WARNING

The heatsink may be hot after the system has been powered down. Allow the heatsink to cool down for a few minutes before removing it.

- 1. Remove the access panel.
- 2. Remove the air duct.
- 3. To remove the PHM:
  - a. Loosen the four screws securing the PHM to the CPU socket anticlockwise in the sequence as shown on the heatsink label with a T30 Torx screwdriver.
  - b. Push the four lock-in wires inward to unlocked position with both hands simultaneously.
  - c. Gently lift the PHM off the CPU socket.

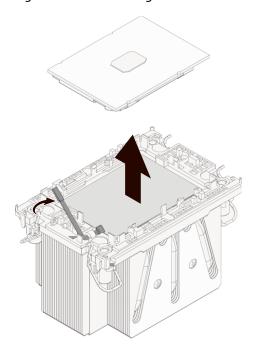
Figure 4-15 Removing the PHM



# CAUTION

- Use a protective cover to protect the CPU socket to avoid damaging socket pins after the PHM has been removed.
- The gold pins on the CPU are fragile and can be easily damaged if touched.
   During removal and installation, always keep the gold pins side up and DO NOT touch the connectors when processor dedicated insertion/removal tool (CPU tray) is unavailable.
- 4. Lift up the lever to release the CPU off the Carrier Clip.
- 5. Pry the tabs securing the CPU to the Carrier Clip. Gently remove the CPU and put it into an antistatic bag.

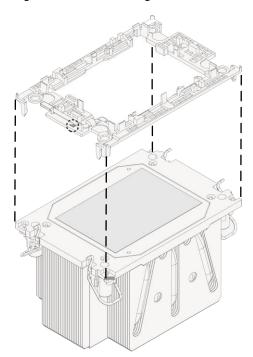
Figure 4-16 Removing the CPU



#### 6. Remove the CPU Carrier Clip:

- a. Close the CPU lever.
- b. Push to release the tab near the printed triangle.
- c. Release the rest three tabs.
- d. Gently lift the CPU Carrier Clip off the heatsink.

Figure 4-17 Removing the CPU Carrier Clip



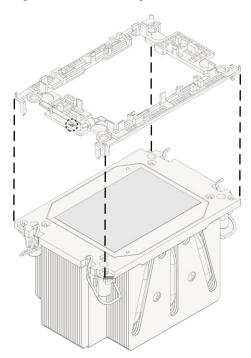


- Use a clean and lint-free cloth to wipe off the old thermal grease first if the heatsink is to be reused.
- Coat thermal grease evenly onto the heatsink before reusing the heatsink.

#### To install the PHM:

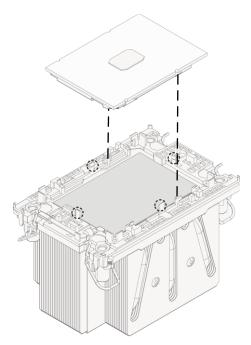
- 1. Install the CPU Carrier Clip:
  - a. With the heatsink thermal grease side up, align the triangle mark on the Carrier Clip with that on the heatsink label.
  - b. Install the Carrier Clip onto the heatsink until the four retaining tabs of the Carrier Clip snap into place.

Figure 4-18 Installing the CPU Carrier Clip



- 2. Apply the thermal grease evenly across the heatsink in the size of the CPU.
- 3. To install the CPU:
  - a. With the gold pins up, align the triangle mark on the CPU with that on the Carrier Clip.
  - b. Grasp CPU by its two edges, and install it into the Carrier Clip. Make sure the notches of the CPU are aligned with the tabs of the Carrier Clip and the CPU is secured in place by the tabs on the four sides of the Carrier Clip.

Figure 4-19 Installing CPU



- 4. Grasp the protective cover (if available) by its short edges to remove it from the CPU socket.
- 5. With the gold pins down, align the triangle mark on the CPU with that on the heatsink to attach the PHM onto the CPU socket.
- 6. Push the four lock-in wires outward to locked position with both hands simultaneously.
- 7. Tighten the four screws securing the PHM to the CPU socket clockwise in the sequence as shown on the heatsink label with a T30 Torx screwdriver.
- 8. Install the air duct.
- 9. Connect the cables of the super-capacitor and M.2 board.
- 10. Install the access panel.

# 4.4.8 PCIe Expansion Card Replacement



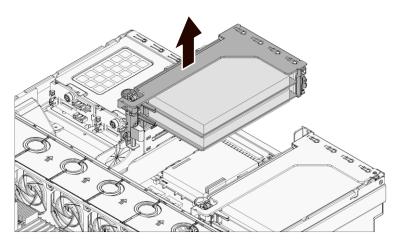
• To prevent damage to the server or expansion cards, power down the server and remove all power cables before removing or installing the PCIe card.

To remove the PCIe expansion card:

1. Remove the access panel.

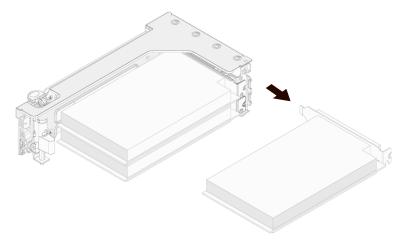
- 2. Disconnect the cables of the Riser card.
- 3. Lift up the blue latch on the PCIe Riser card assembly. Rotate the latch 180° anticlockwise to unlock it.
- 4. Gently lift and remove the PCIe Riser card assembly with both hands.

Figure 4-20 Removing the PCIe Riser Card Assembly



- 5. Disconnect the cables of the PCIe Riser card assembly. Take a record of the cables to avoid wrong cabling when installing.
- 6. Rotate the cover plate to unlocked position.
- 7. Remove the PCIe card from the PCIe Riser cage.

Figure 4-21 Removing the PCIe Card



To install the PCIe expansion card:

- 1. Take the new PCIe card out from the antistatic bag.
- 2. Align and insert the PCIe card to the Riser card slot.

- 3. Close the PCIe cover plate.
- 4. Connect the cables of the Riser card.
- 5. Align and insert the Riser card to the slot on the motherboard.
- 6. Press the blue latch and rotate the latch 180° clockwise to secure the PCIe Riser cage in place.
- 7. Connect the cables of the Riser card.
- 8. Install the access panel.

# 4.4.9 Hot-Swap Storage Drive Module Replacement

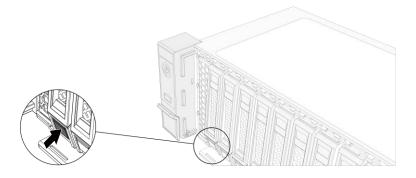


For proper cooling, do not operate the server without the access panel, air ducts, expansion slot covers, or blanks installed. If the server supports hot-swap components, minimize the amount of time the access panel is open.

#### To remove the drive:

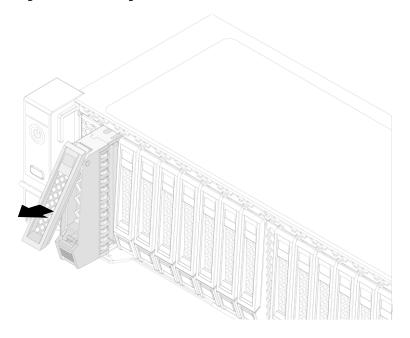
- 1. Remove the hot-swap drive.
  - a. Press the release latch to release the lever. The lever will pop up automatically.

Figure 4-22 Pressing the Release Latch



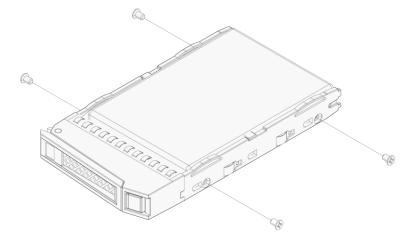
b. Hold the lever and pull the drive module out of the drive bay.

Figure 4-23 Pulling out the Drive Module



c. Remove the four screws securing the drive to the drive tray anticlockwise with a Phillips screwdriver.

Figure 4-24 Removing Screws Securing the Drive to the Drive Tray



#### To install the drive:

- 1. Orient the drive to the drive tray with the drive connector facing the rear end of the tray.
- 2. Tighten the four screws securing the drive to the drive tray clockwise with a Phillips screwdriver.
- 3. Insert the drive module into the drive bay with the lever in the open position.
- 4. Close the release lever to lock the drive module in place.

5. Power on the server and verify that the drive activity status LED is green.

# 4.4.10 Hot-Swap PSU Replacement



#### WARNING

To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching.



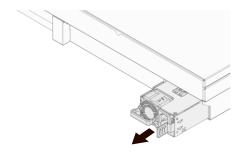
#### CAUTION

To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

#### To remove the PSU:

1. Grasp the handle and press on the blue lever to release the PSU. Pull the PSU out of the power supply bay.

Figure 4-25 Removing the PSU



2. Put it into an antistatic bag.

#### To install the PSU:

- 1. Take the new PSU out from the antistatic bag.
- 2. Insert the PSU into the power supply bay until it clicks into a locked position.
- 3. Power on the server and verify that the PSU LED is green.

### 4.4.11 OCP Card Replacement



#### CAUTION

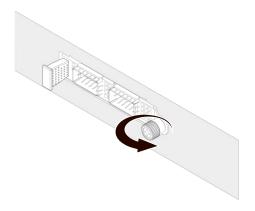
#### OCP card is hot-swappable:

- Before removing the OCP card with the system power on, press the hotswap button with LED and wait till the LED turns off.
- After installing the OCP card with the system power on, press the hotswap button with LED, the LED turns green.

#### To remove the OCP card:

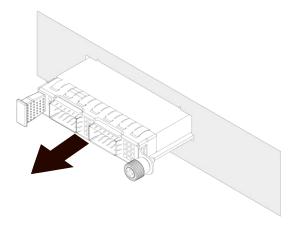
1. Loosen the thumbscrew securing the OCP card to the chassis anticlockwise.

Figure 4-26 Loosening the Thumbscrew



2. Pull the OCP card horizontally out of the chassis.

Figure 4-27 Removing the OCP Card



3. Put it into an antistatic bag

To install the OCP card:

- 1. Take the new OCP card out from the antistatic bag.
- 2. Insert the OCP NIC into the card slot until it snaps into place.

- 3. Tighten the thumbscrew securing the OCP card to the chassis clockwise.
- 4. After pressing the OCP hot-swap button with LED, verify that the LED turns green.

# 4.5 Firmware Update and Configuration

For update and configuration of firmware, refer to:

- BMC Update Manual
- BMC Configuration Manual
- BMC User Manual
- BIOS Update Manual
- BIOS User Manual

# 4.6 Cable Routing

Blue indicates the data cable routing between the backplane and SAS/RAID card;

Red indicates the cable routing between the backplane power connector and the motherboard power connector for powering the drives.



To prevent damage to electrical components, properly ground the server before installation. Improper grounding can cause electrostatic discharge.

Figure 4-28 Cable Routing of 12 × 3.5-inch Drive System

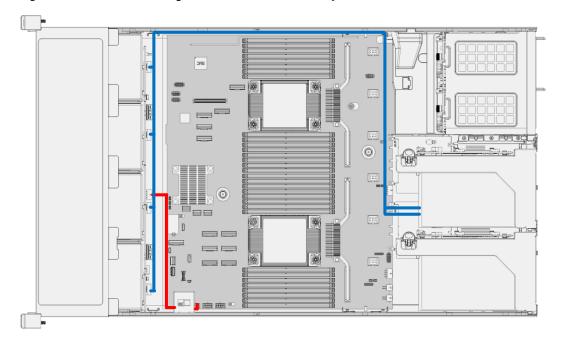
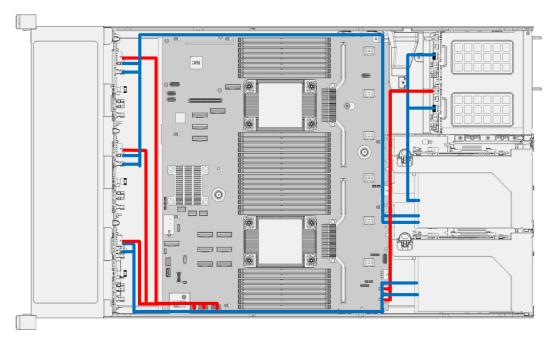


Figure 4-29 Cable Routing of 24 × 2.5-inch Drive System



# 5 Battery Replacement



The server CMOS contains an internal lithium cell. A risk of fire and burns exists if the battery is not properly handled. To reduce the risk of personal injury:

- DO NOT recharge the battery.
- DO NOT expose the battery to temperatures higher than 60°C (140°F).
- Do not disassemble, crush, puncture, short external contacts, or dispose of the battery in fire or water.
- Replace only with the spare designated for this product.
- After replacing the battery, you must reconfigure the server and reset the system date and time.

#### To remove the battery:

- 1. Power down the server and disconnect the power cables from the server.
- 2. Gently slide and remove the server out of the rack.
- 3. Remove the access panel.
- 4. Disconnect the cables of the super-capacitor and M.2 board.
- 5. Remove the air duct.
- 6. Locate the battery on the motherboard.
- 7. Gently press the clip on the battery socket until the battery pops up from the socket. Remove the battery.

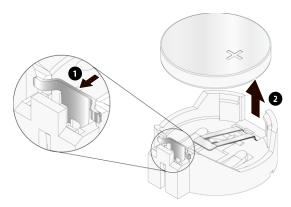


The drawings shown below are for illustration only. The location and orientation of the cell may differ depending on the model you purchased.

# **A** CAUTION

- DO NOT pry or press the battery using excessive force.
- Failing to remove the battery properly might damage the socket on the motherboard.

Figure 5-1 Removing the Battery



8. Dispose of the battery as required by local ordinances or regulations.

#### To install the battery:

- 1. Take the new battery out from the anti-static package.
- 2. Place the new battery into the socket, being careful to observe the correct polarity. Snap the battery into place. Make sure the battery is secured by the clip within the socket.
- 3. Install the air duct.
- 4. Connect the cables of the super-capacitor and M.2 board.
- 5. Install the access panel.

# 6 Electrostatic Discharge

# 6.1 Preventing Electrostatic Discharge

To prevent damage to the system, be aware of the precautions you need to follow when setting up the system or handling parts. A discharge of static electricity from a finger or other conductor may damage system boards or other static-sensitive devices. This type of damage may reduce the life expectancy of the device.

To prevent electrostatic damage:

- Avoid hand contact by transporting and storing products in static-safe containers.
- Keep electrostatic-sensitive parts in their containers before they arrive at static-free workstations.
- Place parts on a grounded surface before taking them out from their packages.
- Avoid touching pins, leads, or circuitry.
- Always be properly grounded when touching a static-sensitive component or assembly.

# 6.2 Grounding Methods to Prevent Electrostatic Discharge

Several methods are used for grounding. Use one or more of the following methods when handling or installing electrostatic-sensitive parts:

- Use a wrist strap connected by a ground cord to a grounded workstation or computer chassis. Wrist straps are flexible straps with a minimum of 1 megohm ±10 percent resistance in the ground cords. To provide proper ground, wear the strap snug against the skin.
- Use heel straps, toe straps, or boot straps at standing workstations. Wear the straps on both feet when standing on conductive floors or dissipating floor mats.
- Use conductive field service tools.
- Use a portable field service kit with a folding static-dissipating work mat.

If you do not have any of the suggested equipment for proper grounding, have an authorized reseller install the part.

For more information on static electricity or assistance with product installation, contact Inspur Customer Service.

# 7 Troubleshooting

### 7.1 Hardware Problems

#### Power-On Failure

#### **Symptoms:**

After pressing the power button, the power LED on the power button is orange and the drive activity status LED is off. Meanwhile, there is no output on the monitor, and server fans do not rotate.

#### **Solutions:**

Check the status of the PSU LEDs on the rear panel.

- 1) The PSU LEDs are off or amber
- 1.1) If the PSU LEDs are off or amber, it indicates abnormal power supply. Check if the outlet can function, if the power cords are plugged properly and if the power cables of the faulty PSU can work;
- 1.2) If all yes: the PSU LEDs are still off or amber, maybe the PSUs are faulty. Please replace the faulty PSUs with PSUs of the same server model and of the same specifications to test whether the PSUs have failed; the PSU LEDs turn green, but the power LED on the power button is still orange, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailto:serversupport@inspur.com">serversupport@inspur.com</a>.
  - 2) All the PSU LEDs are green
  - 2.1) If all the PSU LEDs are green, disconnect the power cables, remove and re-insert all the PSUs. Connect the power cables and power on again to test if the problem can be solved;
  - 2.2) If re-inserting the PSUs won't work, please replace the PSUs with PSUs of the same server model and of the same specifications to test whether the PSUs have failed;
  - 2.3) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailto:serversupport@inspur.com">serversupport@inspur.com</a>.

#### No Display

#### **Symptoms:**

After pressing the power button, the power LED on the power button changes from orange to green, the system fans work normally, but there's no output on the monitor.

#### **Solutions:**

- 1) Check whether the monitor is powered up normally;
- 2) If yes, but there is still no output on the monitor, check whether the monitor is connected properly to the server's VGA port;
- 3) If yes, but there is still no output on the monitor, please replace with another monitor;
- 4) If the problem still persists, maybe the VGA port is abnormal. Please log into the BMC Web interface. Launch the BMC remote KVM (For detailed reference document, please see <a href="Firmware Update and Configuration">Firmware Update and Configuration</a>) to see if KVM can be displayed normally: If yes, maybe the VGA port on the motherboard is abnormal, please contact Inspur Customer Service; if no, please record the detailed warning information;
- 5) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailto:serversupport@inspur.com">serversupport@inspur.com</a>, and inform us of the detailed warning information and failure.

#### Abnormal LED on the Front Panel

#### **Symptoms:**

The status LED on front panel illuminates red.

#### **Solutions:**

Identify the abnormal LED based on Front Panel Buttons and LEDs

- 1) If the system status LED illuminates red, check whether the server is under normal operation: If yes, log into the BMC Web interface to view the BMC logs (For detailed reference document, please see <a href="Firmware Update and Configuration">Firmware Update and Configuration</a>) to check whether there are warnings. If yes, please record the detailed warning information;
- 2) If the power status LED is abnormal, please check if the PSU LEDs on the rear panel are abnormal (amber or off): If the PSU LEDs are normal, please log into the BMC Web interface to check the BMC logs (For detailed reference document, please see <a href="Firmware\_brown">Firmware\_brown</a> Update and Configuration) to see if there are warnings. If yes, please record the detailed warning information; if all the PSU LEDs are abnormal, please refer to All the

<u>PSU LEDs are green</u>; if one PSU LED is abnormal, please refer to <u>PSU LED Off or Illuminates Amber</u>;

- 3) If other status LEDs are abnormal, log into the BMC Web interface to check the BMC logs to see if there are warnings; if yes, please record the detailed warning information;
- 4) If the instructions above do not locate or resolve the problem, please call Inspur

  Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to

  serversupport@inspur.com, and inform us of the detailed warning information and
  failure.

#### Stuck in POST Interface or Other Interface

#### **Symptoms:**

After pressing the power button, the server gets stuck in the POST interface or other interface and cannot enter the OS.

#### **Solutions:**

- 1) If the server gets stuck in the media test failure interface, please confirm if OS is installed successfully and OS boot order is set to first;
- 2) If the stuck interface includes directional error information of hardware, such as selftest errors of memory and RAID, record the detailed errors;
- 3) If the stuck interface is the POST interface and there are errors reported in the interface, please record the detailed errors;
- 4) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailto:serversupport@inspur.com">serversupport@inspur.com</a>, and inform us of the detailed errors.

#### PSU LED Off or Illuminates Amber

#### **Symptoms:**

A certain PSU LED on the rear panel is off or illuminates amber when the server is under normal operation.

#### **Solutions:**

1) Check if there is normal external power supply. Inspect the server for any abnormal appearance such as burning or vulcanization;

- 2) Check whether the power cord is plugged in firmly. Re-connect the power cable again.
- 3) If the fault still exists, remove the power and insert the PSU again.
- 4) Shut down the server (if shutdown is allowed), switch the positions of the PSUs and cross-check whether the PSU is faulty.
- 5) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to serversupport@inspur.com.

#### Abnormal Drive Status LED

#### **Symptoms:**

The drive activity status LED is off or the drive fault LED illuminates red when the server is under normal operation.

#### **Solutions:**

- 1) Check if the drives are installed properly;
- 2) Check whether the drivers are removed and inserted or if there are other manual operations. If yes, restore the array through RAID configuration to ensure the drives are configured properly;
- 3) If no, run command under the OS to see if all the drives are identified. If the server is configured with an RAID card, you can also choose to log into the RAID management interface to check whether there is a drive failure:
- 4) If there is a drive failure or the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailto:serversupport@inspur.com">serversupport@inspur.com</a>.

### NOTE

- Hot-plug storage drive allows users to remove or replace the drive without shutting down or powering off the system, which improves the system disaster recovery capability, scalability and flexibility. It only means that the hot-plug storage drive can be plugged in and out online without damage.
- Depending on the RAID level, hot-plugging a storage drive in the RAID may cause RAID degradation or failure. When installing a new drive, different

- RAID cards have different policies. You may need to log into the RAID management interface for recovery.
- Remove the drive until the drive motor stops completely in order to prevent damage to the motor.

#### Loud System Fan Noise

#### **Symptoms:**

System fans make excessive noise when the server is under normal operation.

#### **Solutions:**

- Check the fan status LED or other status LEDs on the front panel for any warnings.
   Meanwhile, ensure that the access panel is closed properly and the air duct has not been moved;
- 2) Check the server temperature by hand or the sensor temperature in the BMC Web interface for over-temperature;
- 3) If the temperature of the chassis is too high, check the temperature of the server room.

  If it is too high, adjust the air conditioner to cool the room;
- 4) If the temperature of the server room isn't high, check whether the front bezel or chassis interior is jammed with dust. If yes, clean with a soft and dry cloth, or a specialized brush. The environment of the server room needs to be improved to avoid over-temperature running of the server caused by too much dust;
- 5) Check if the server is operating under heavy load. Log into the BMC Web interface to see if all the fans are identified and if the fan mode is automatic;
- 6) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailto:serversupport@inspur.com">serversupport@inspur.com</a>.

#### Alarm Sound from the Server

#### **Symptoms:**

There is an alarm sound during server startup or operation.

Find the source of the alarm sound:

- 1) If the alarm sound comes from the PSUs, check the status of the PSU LEDs on the rear panel. If the PSU LEDs are abnormal, refer to <u>PSU LED Off or Illuminates Amber</u> to handle it.
- 2) If the alarm sound comes from the chassis interior, remove the access panel to find the specific source;
- 3) If the alarm sound comes from the RAID card, check the drive fault LED for any warning or log into the RAID management interface for any drive warning and record the detailed warning information if any.
- 4) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailto:serversupport@inspur.com">serversupport@inspur.com</a>, and inform us of the alarm source and detailed warning information.

#### Keyboard and Mouse Failure

#### **Symptoms:**

Neither keyboard nor mouse can function.

#### **Solutions:**

- 1) Make sure the keyboard and mouse have been connected properly and firmly.
- Connect the keyboard and mouse to a laptop or a server to test if they can function or not;
- Power cycle the server and retest;
- 4) Restart the server and enter BIOS or RAID management interface to test if the keyboard and mouse can function: If the keyboard and mouse can function in non-OS environment, maybe there is something wrong with the USB driver of the OS; if the keyboard and mouse cannot function in non-OS environment, then maybe the connector on the motherboard is faulty. Please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailtoserversupport@inspur.com">serversupport@inspur.com</a>.

#### USB Port Problem

#### **Symptoms:**

Unable to use devices with a USB port.

#### **Solutions:**

- 1) Make sure the OS of the server supports USB devices;
- 2) Make sure the server has been installed with the correct USB driver, and try installing the USB driver again;
- 3) Connect the USB device to another server to test if the device can function;
- 4) If the USB device cannot function, please replace with a known working USB device;
- 5) Power cycle the server and retest;
- 6) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to serversupport@inspur.com.

### 7.2 Software Problems

#### OS Installation Problems

#### **Symptoms:**

Unable to load the RAID driver or create partitions larger than 2 T during OS installation; C disk usage is too high after OS installation, etc.

- 1) If it fails to load the driver during OS installation, check the RAID driver version. Go to Inspur website <a href="https://en.inspur.com">https://en.inspur.com</a> to download the correct RAID driver. Some RAID drivers need to be loaded several times.
- 2) If it fails to create partitions larger than 2 T during OS installation, select
  - Advanced>CSM Configuration>Boot option filter>UEFI only (For detailed reference document, please see Firmware Update and Configuration) in BIOS, save and exit BIOS interface. Choose UEFI to boot the OS. The server will restart automatically. It needs to enter the CMD command line to change the drive format to GPT, and then partitions larger than 2 T can be created;
- 3) If the C disk usage is too high after installing the Windows OS, turn down the virtual memory or allocate the virtual memory to other partitions;
- 4) If the instructions above do not resolve the problem, please call Inspur Customer

Service Hotline (1-844-860-0011/1-760-769-1847) or email to serversupport@inspur.com.

#### PXE Boot Failure

#### **Symptoms:**

Unable to install OS via PXE.

#### **Solutions:**

- 1) Check if the PXE server can be used to install OS for another server;
- 2) Check whether there is network link via the network port LED to check if there is a fault in external network;
- 3) Check whether the NIC can be identified under BMC Web, BIOS or Shell;
- 4) Check if PXE Function is enabled and if the boot sequence is set to first in BIOS;
- 5) Check if the target drive for the OS or RAID array can be identified and if there is enough space;
- 6) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to serversupport@inspur.com.

### Abnormal Memory Capacity

#### Symptoms:

The memory capacity displayed in the OS and the physical memory capacity are inconsistent.

- 1) Check the OS version. The supported memory capacity varies with the version of Windows OS. Enter BIOS Setup to view the memory capacity. If the memory is identified completely, the OS may be unable to access all the installed memories. For example, Windows server 2008 x86 supports up to 4 G memory;
- 2) If the memory is not identified completely in BIOS Setup, confirm that the corresponding slots have been populated with memories of correct type;
- 3) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to

#### serversupport@inspur.com.

#### Abnormal Network

#### **Symptoms:**

The network is disconnected, or the rate is lower than the actual rate of the network port under the server OS.

- 1) Check whether the network cable is connected properly and whether the network port LED flashes normally to ensure that the network is configured correctly;
- 2) Unplug and plug the network cable back to see if the problem can be solved. If not, connect the server with a laptop via a known working network cable: If the network is normal, check the network cable or the switch port; if the network is faulty, go to Inspur Website <a href="https://en.inspur.com">https://en.inspur.com</a> to download the latest NIC driver;
- 3) Check whether the NIC can be identified under BMC Web, BIOS or Shell and whether the MAC address is correct;
- 4) If the instructions above do not resolve the problem, please call Inspur Customer Service Hotline (1-844-860-0011/1-760-769-1847) or email to <a href="mailto:serversupport@inspur.com">serversupport@inspur.com</a>, and inform us of the detailed warning information and failure.

# 8 Environmental Requirements

# 8.1 Ambient Temperature

Table 8-1 Ambient Temperature

Parameter	Condition	Requirement		
	Operating continuously	10°C - 35°C (50°F - 95°F)		
T	Transportation (Storage)	-40°C - 70°C (-40°F - 158°F)		
Temperature	Maximum temperature gradient (Operation and storage)	20°C/h (36°F/h)		
	Operations	Relative humidity is 10% to 90% with maximum dew point at 32°C (89.6°F)		
Humidity	Transportation (Storage)	Relative humidity is 5% to 95% with maximum dew point at 39°C (102.2°F), and the air must be non-condensing all the time		

# 8.2 Vibration and Shock Resistance

Table 8-2 Vibration and Shock Resistance

Parameter	Condition	Requirement
	Operating	5 - 500 Hz: 0.21 Grms (X, Y and Z axis and every direction for 15 minutes)
Vibration	Storage	5 - 500 HZ: 2.2 Grms (X. Y and Z axis and every direction for 10 minutes)
	Transportation	1 - 200 HZ: 0.82 Grms (X. Y and Z axis and every direction for 30 minutes)
Shock	Operating	On negative and positive X, Y and Z axis direction, each axis can withstand

Parameter	Condition	Requirement
		100 continuous 2 G shock pulses for up to 11 ms
	Storage	On negative and positive X, Y and Z axis direction, each axis can withstand two square wave shock pulses of 40 G in a row with the speed change at 156 inch/s
	Transportation	On X, Y and Z axis direction, each axis can withstand 1000 continuous 40 G shock pulses for up to 6 ms

# 8.3 Altitude and Air Pressure

Table 8-3 Altitude and Air Pressure

Parameter	Condition	Requirement
	Operating	0 to 3,048 m (0 to 10,000 feet)
Altitude	Transportation (Storage)	0 to 12,000 m (0 to 39,370 feet)

# 8.4 Alternating Temperature and Humidity

Table 8-4 Alternating Temperature and Humidity

Parameter	Condition	Requirement
	Operating	Relative humidity is 10% to 90% with maximum dew point at 38°C (100.4°F)
Humidity	Transportation (Storage)	Relative humidity is 5% to 95% with maximum dew point at 39°C (102.2°F), and the air must be non-condensing all the time m

# 8.5 Extended Operation Temperature



- 1. The system performance will be impacted when the temperature is not within the specification range;
- 2. Ignore alarm sound of ambient temperature when the temperature is not within the specification range.

Table 8-5 Extended Operation Temperature

Temperature Specification (Numbers are for instance only)	Note
5°C - 40°C (5% - 85%RH)¹	Continuous running is possible
-5°C - 45°C (5% - 90%RH)²	Running time ≤1% per year

# 8.6 Extended Operation Temperature Limits

- Powering on under 5°C (41°F) is not allowed;
- The altitude cannot be higher than 3,000 m (9,843 feet);
- Only specified PCIe cards are supported;

## 8.7 Thermal Limit



Power consumption is not the only parameter in measuring the thermal performance of the CPU. For customized CPUs, special model CPUs with surface temperature lower than standard CPUs, and CPU models with non-standard heatsinks as clearly instructed by Intel, the following table may not apply.

Table 8-6 Thermal Limit 1

Configuration	Front Drive	Internal Drive	Rear Drive	СРИ	GPU	Max Temp.
General configuration 1	12 × 3.5-inch drive	/	4 × NVMe/SA S	≤220 W	Not supporte d	≤35°C
General configuration 2	12 × 3.5-inch drive	/	2 × NVMe/SA S	≤270W	Not supporte d	≤35°C
General configuration 3	24 × 2.5-inch drive	/	2 × NVMe/SA S	≤270W	Not supporte d	≤35°C

Table 8-7 Thermal Limit 2

Configuratio n	Front Drive	Internal Drive	Rear Drive	CPU	GPU	BPS	Max Temp.
General configuratio n 1	12 × 3.5- inch drive	Not support ed	Not suppo rted	No limit	Not supporte d	16 DIMMs + 16 BPS	≤35°C
GPU configuratio n 1	8 × 3.5- inch drive	Not support ed	Not suppo rted	No limit	T4 or GPUs of equivale nt power supporte d	Not supporte d	≤35°C(95 °F)  No higher than 25°C when redunda nt fans are equippe d

# 8.8 Operational Requirement

This section specifies the requirements of temperature, humidity, organisms, chemical materials and mechanically active materials in the server room when the server is operating.

#### 1. Temperature and humidity

The temperature, dew point and relative humidity in the server room should meet the requirements for operating the server. For specified requirements, see the detailed description in the product documentations.

#### 2. Organisms

Plants and animals are not allowed in the server room. Take strict precautions against damage by rats and ants.

To meet these requirements, take the following measures in the server room:

- Ensure safety if there are humidification devices in the server room.
- All the structures and construction gaps of doors, windows, walls, ground (floors) must be sealed.
- If there are water supply and drainage pipes in the server room, anti-leakage and anti-condensation measures should be taken.
- If there is water equipment in the main server room, measures to prevent water overflow and leakage should be taken.
- Block cable holes and antenna holes.
- Clean and sterilize the server room periodically.

#### 3. Corrosive Airborne Contaminants

Generally, a small amount of common corrosive gas pollutants exist in indoor and outdoor atmospheric environments. Chemical reactions may occur due to long-term contact between these mixed corrosive gas pollutants or pollutants of one single corrosive gas and other environmental factors (such as temperature or relative humidity), which may pose a risk of IT equipment failure from corrosion and damage circuit boards of IT equipment and system component units with weak oxidation resistance. This article specifies the limitation on corrosive airborne contaminants with an aim to avoid such risks.

The concentration level of corrosive airborne contaminants in a data center shall meet the requirements listed in the white paper entitled Gaseous and Particulate Contamination Guidelines for Data Centers published in 2011 by American Society of Heating Refrigerating and Air-conditioning Engineers (ASHRAE) Technical Committee (TC) 9.9. According to the Guidelines, corrosive airborne contaminants in a data center shall meet the following requirements:

- Copper coupon corrosion rate less than 300 Å/month per ANSI/ISA-71.04-2013 severity level G1
- Silver corrosion rate less than 200 Å/month per ANSI/ISA-71.04-2013 severity level G1
- According to ANSI/ISA-71.04-2013 Environmental Conditions for Process
  Measurement and Control Systems: Airborne Contaminants, the gaseous
  corrosively levels are G1 (mild), G2 (moderate), G3 (harsh), and GX (severe), as
  described in Table 8-8.

Table 8-8 Gaseous Corrosively Levels per ANSI/ISA-71.04-2013

Severity Level	Copper Reactivity Level	Silver Reactivity Level	Description
G1 (mild)	< 300 Å/month	< 200 Å/month	An environment sufficiently well-controlled such that corrosion is not a factor in determining equipment reliability.
G2 (moderate)	< 1000 Å/month	< 1000 Å/month	An environment in which the effects of corrosion are measurable and may be a factor in determining equipment reliability.
G3 (harsh)	< 2000 Å/month	< 2000 Å/month	An environment in which there is high probability that corrosive attack will occur.
GX (severe)	≥ 2000 Å/month	≥ 2000 Å/month	An environment in which only specially designed and packaged equipment would be expected to survive.

See Table 8-9 for the requirements on the copper and silver corrosion rates.

Table 8-9 Concentration Limitation on Corrosive Airborne Contaminants in a Data Center

Group	Gas	Unit	Concentration
	H₂S	ppb <sup>a</sup>	<3
Croup A	SO <sub>2</sub>	ppb	<10
Group A	Cl <sub>2</sub>	ppb	<1
	NO <sub>2</sub>	ppb	<50

Group	Gas	Unit	Concentration
	HF	ppb	<1
Group B	NH₃	ppb	<500
	O <sub>3</sub>	ppb	<2

a: Part per billion (ppb) is the number of units of mass of a contaminant per 1000 million units of total mass.

Group A and group B are common gas groups in a data center. Group A's or group B's concentration limitation values correspond to copper and silver reactivity level G1.

Corrosion is not determined by a single factor, but by comprehensive environmental factors such as temperature, relative humidity and corrosive airborne contaminants. Any change of the environmental factors may affect the gaseous corrosively level. Therefore, the concentration limitation values specified in the previous table are for reference only. If the actual mixed gas concentration is not listed in the table, refer to chemically active substance level in IEC-60721-3-3 or GB/T 4798.3-2007 to choose the concentration range.

#### 4. Mechanically Active Materials

The server room should be free from explosive, conductive, magnetismpermeable, and corrosive dust. Table 8-10 lists the requirements for concentration of the mechanically active materials in the server room

Table 8-10 Requirements for Concentration of Mechanically Active Materials

Mechanically Active Materials	Unit	Concentration
Sand	mg/m³	≤30
Suspending dust	mg/m³	≤0.2
Dust deposit	mg/(m²h)	≤1.5

To meet these requirements, take the following measures in the server room:

- Use dustproof materials on the ground, wall, and ceiling of the server room.
- Adopt few or no windows design in the server room, and use dustproof materials for outer windows.
- Clean the server room, especially the air filters periodically.
- Wear shoe covers and ESD clothing before entering the server room.

# 8.9 Electromagnetic Compatibility Requirements

1. As per GB/T 17626.3 (IEC 61000-4-3) & GB/T 17626.6(IEC 61000-4-6) & GB/T 17626.8 (IEC 61000-4-8), the recommended electromagnetic environment is as follows:

Table 8-8 Recommended Electromagnetic Environment

Electromagnetic Phenomenon		Specifications
Power frequency magnetic field	Frequency (Hz)	50
	A/m (rms)	≤1
RF electromagnetic field amplitude modulation	Frequency (MHz)	80 - 1000
	V/m (rms, unmodulated)	≤3
	%AM (1kHz)	80
RF continuous wave	Frequency (MHz)	0.15 - 80
conduction	V (rms, unmodulated)	≤3
	%AM (1kHz)	80

Meanwhile, we recommend you to take the following measures to suppress interfering signals:

- Take effective measures against power grid interference to the power supply system.
- Keep away from electrical equipment such as medical magnetic resonance device, helium arc welder, radio frequency electric heater, etc.
- Try to avoid the impact of nearby areas with high power emissions (broadcast, radar, mobile communication transmitters), electrified railways, industrial radiation, substations, and high-voltage transmission lines.
- The interference effect of other equipment in the server room must comply with relevant standards and regulations.
- Take measures to shield and isolate natural noise such as atmospheric noise and solar radio noise when necessary.

To avoid damage to the system, take ESD protection measures. For more

information on electrostatic protection methods, refer to **Electrostatic Discharge**.

- 2. As per the requirements of Appendix F.5 of IEC6268, the server is pasted with safety protection logos. The logos and interpretations are as follows:
- 1) Fan blade safety protection:

Figure 8-1 Fan Blade Safety Protection



Caution: Keep body parts away from fan blades

2) Multi-power safety protection:

Figure 8-2 Multi-power Safety Protection



Caution: Shock Hazard! Disconnect all power supply cords before servicing.

# 8.10 Power Supply Requirements

### 8.10.1 AC Power Supply Requirement

An AC power supply that consists of mains supply, uninterruptible power supply (UPS), and self-supplied electric generator set can be used as an integrated power supply. The AC power supply must feature simple connection line, safe operation, flexible scheduling, and easy maintenance in addition to meeting the requirements of site load. Low voltage power supply should adopt three-phase five-wire mode or monophase three-wire mode.

AC power supply system should work under nominal voltage and rated frequency.

Table 8-9 Nominal Voltage and Rated Frequency

Nominal Voltage	Rated Frequency
110 V, 208 V	60 Hz
220 V, 380 V	50 Hz

A UPS is typically used as an AC potential power of network products. A UPS should be in the same phase as the mains supply. The time used for switching between the UPS and the mains supply should be less than 8 ms. Otherwise, the server will reboot or reset.

#### 8.10.2 DC Power Supply Requirement

DC power supply system should work under nominal voltage of -48 V, 240 V and  $380 \, \text{V}$ .

When determining the AC distribution capacity in the server room, consider the working current and fault current. An independent device must have an independent AC distribution protection apparatus. The maximum capacity of the current over the configuration protection switch should be greater than the maximum capacity of the current over the protection switch of each device. When designing the capacity of an AC power supply system, consider the maximum load of the system in dynamic mode and static mode and reserve a certain margin. The cabling on the power distribution panel must be figured out based on the maximum power supply load. This helps you determine the type and size of the conducting wire.

Voltages of an AC-powered server and power equipment should meet the following requirements:

- For an AC-powered server, the voltage fluctuates from -10% of the rated voltage to +10% of the rated voltage.
- For AC-powered power equipment and important buildings, the voltage fluctuates from -10% of the rated voltage to +10% of the rated voltage.
- The AC frequency fluctuates from -4% to 4%. The sinusoidal distortion rate of the voltage waveform is smaller than or equal to 5%.

The server room should be equipped with a self-supplied electric generator set. The electric generator set should perform automatic power-on/off, automatic recruitment, remote communication, remote control, and remote detection, and provide standard interfaces that comply with communication protocols.

The power cable used for AC/DC power distribution should meet the following requirements:

- The conductor in the neutral wire must have the same cross-sectional area as the conductor in the live wire.
- The power feeder should be selected based on the long-term load. If the cross-sectional area exceeds 95 mm<sup>2</sup>, a hard bus cable should be used. If there is a great difference between the short-term load and the long-term load, cables can be routed by stage.

 AC/DC conducting wires should be flame-retardant and be routed according to the Code for fire protection design of tall buildings (GB50045).

#### 8.10.3 Recommendations on the AC Power Supply

Recommendations on the AC power supply are as follows:

- Use a voltage stabilizer or voltage-regulator to respond to unstable voltages. Use a voltage-regulator in the following situations:
  - The server is directly powered by the mains supply, and the power supply voltage exceeds the rated voltage by -10% to +10% or the voltage range allowed for the server.
  - The server is not directly powered by the mains supply, and the mains voltage exceeds the rated voltage by -10% to +10% or the AC input voltage range allowed for the DC power equipment.
- To prevent interruption or surge of AC power supply, use the UPS or inverter.
- The data center should be equipped with self-supplied generator set in case of mains failure to ensure proper function of important load and important power load. All electrical equipment such as IT equipment and refrigeration equipment shall be considered. Check the start-up shock to ensure that the generator can start reliably. The generator performance should meet the requirements of Code for Design of Data Centers (GB50174).
- Connect two storage battery strings in parallel. A second UPS is needed as backup.

# 8.10.4 HVDC Power Supply

The high-voltage direct current (HVDC) system can eliminate the problems existing in conventional AC and low-voltage DC power supplies. At present, 240 V HVDC standards and 336 V HVDC standards are the mainstream HVDC standards used in China.

### 8.10.5 HVDC Power Supply Requirements

- The requirements for HVDC power supply are as follows:
- Operating range:  $0^{\circ}$ C  $45^{\circ}$ C ( $0^{\circ}$ F  $113^{\circ}$ F)
- Storage and transportation range:  $-40^{\circ}\text{C}$   $85^{\circ}\text{C}$  ( $-40^{\circ}\text{F}$   $185^{\circ}\text{F}$ )
- Relative Humidity:
- Operating range:  $\leq$  90% RH (40 ± 2°C)
- Storage and transportation range:  $\leq$  95% RH (40 ± 2°C)

- Vibration performance: ability to withstand sinusoidal frequencies between 10 Hz to 55 Hz and amplitude of 0.35 mm.
- Battery capacity configuration: ensure continuous operation of servers at full loads when the power supplies are unavailable. The battery backup time should be 15 minutes when a diesel generator is available as backup power source.
- Determination of cell voltage and pack number: Depending on the system capacity and backup time, the cell voltage can be selected from 2 V, 6 V or 12 V.
- The insulation monitoring device acts properly if a ground fault occurs or the insulation resistance is  $28 \text{ k}\Omega$  lower than the set value. The HVDC system is protected against overcurrent and short circuits and can be manually or automatically restored after overcurrent or short circuits are rectified.
- Over- and under-voltage protection for AC power supplies: The power supply system can monitor the input voltage changes. When detecting that the AC input voltage is higher or lower than the specified threshold, which may pose safety risk on the operation of the power supply system, the system automatically shuts down. The system automatically restores when the input voltage is normal.
- The site is free from explosive materials, conductive media and hazardous gases that erode metals and affect insulation, and mold.
- Protection against high temperature: When the temperature in the power supply system reaches the specified threshold, the power supply system automatically reduces the power or shuts down the power amplifier. When the temperature falls below the threshold, the power supply system restores the normal power output.
- The system provides alarm records and query, and the alarm display can be updated on a real-time basis. The alarm information is protected against loss when the system is out of power.

# 8.10.6 HVDC Power Supply Suggestions

- Terminal equipment can be connected to power sockets or wiring terminals.
   Wiring terminals are recommended.
- Do not use a shunt circuit breaker to connect to or control multiple power modules through a multi-purpose power socket.
- Choose DC circuit breakers based on the rated current of the equipment. The 10 A or 16 A DC breakers are recommended.
- Recommended standards for equipment power wiring: Connect the DC output positive pole to terminal N of the equipment power cable. Connect the DC

- output negative pole to terminal L of the equipment power cable. DC system is strictly forbidden to be grounded.
- The upstream input terminal of the power supply system is equipped with a surge protection device to protect the system against a minimal voltage surge of 10/700 us, 5 kV and a minimal current surge of 8/20 us, 20 kA.
- All cables in the power distribution frame (PDF) comply with YD/T 1173 specifications, and the diameters of all power cables meet the requirements for wire ampacity.

#### 8.10.7 DC Power Supply

The DC power supply should be stable and reliable. The power equipment should be deployed near the server. The standard DC voltage is -48 VDC with a fluctuation range of server power between -40 V to -72 V.

# 9 Warranty

Inspur warrants that all Inspur-branded hardware products shall be free from material malfunctioning and material defects under conditions of normal use for a period of three (3) years from the Date of Invoice.

Service offerings may vary by geographic region. Please contact your Inspur representative to identify service levels and needs for your regions.

# 9.1 Warranty Service

#### **Remote Technical Support**

Inspur warranty service includes 24/7 remote technical support and 3-year part replacement throughout the warranty period. Warranty Service are Advance Replacement Service in the first year and Standard Replacement Service in the second and third years.

Table 9-1 Warranty Service Type and Duration

Туре	Duration
Remote Technical Support	3 years
RMA Services	3 years

The 24/7 remote technical support can be obtained through hotline, e-mail, and Service Portal\*1. Through hotline and e-mail support, Inspur engineers help customers diagnose the cause of malfunction and provide solution. Service Portal\*1 provides access to firmware, customized update files, and related manuals for Inspur products. Customer may also access the Service Portal\*1 to submit Return Material Authorization (RMA) for parts replacement or repair.

Information needed when requesting for support:

- Contact name, phone number, e-mail address
- System Serial Number, Part Number, Model and location (address) of the product needing service
- Detailed description of problem, logs (sel and blackbox, and any other related logs from OS), screenshot of issue, pictures of damaged/questions parts, etc.

Table 9-2 Support Contact Information

Туре	Description	Support Window
Global Hotline	Global: 1-844-860-0011/1-760-769-1847 (English) China: 400-860-0011 (Chinese)	24 × 7 × 365
Email	Global: <u>serversupport@inspur.com</u> China: <u>lckf@inspur.com</u>	24 × 7 × 365
	US**: <a href="mailto:serversupportusa@inspur.com">serversupport_kr@inspur.com</a> Japan: <a href="mailto:serversupport_jp@inspur.com">serversupport_jp@inspur.com</a>	Local business hours 9AM to 6PM Monday to Friday **US: PST (GMT -8)
Service Portal*1	US**: http://service.inspursystems.com/login.htm EU: http://eurportal.inspur.com/	Local business hours 9AM to 6PM Monday to Friday **US: PST (GMT -8)

#### **RMA Services**

Inspur may, at its discretion, repair or replace the defective parts. Repair or Replacement parts may be new, used, or equivalent to new in performance and reliability. Repaired or replaced parts are warranted to be free of defects in material or workmanship for ninety (90) calendar days or for the remainder of the warranty period of the product, whichever is longer.

**Advance Replacement**: Under the terms of Advance Replacement Service, if a problem with customer product cannot be resolved via hotline and e-mail support and a replacement part is required, Inspur will ship out replacement part(s) in advance within one (1) business day. Customer should return defective part(s) within five (5) business days after receiving the replacement(s). Inspur will cover one-way shipment via ground.

**Standard Replacement**: When a hardware failure happens, customer may submit RMA request to Inspur via e-mail or Service Portal\*<sup>1</sup>. Inspur will review and approve RMA submission, and provide an RMA number and return information that customer may use to return for RMA service. Inspur will ship out replacement part(s) within one (1) business day after receiving the defective part(s) and cover one-way shipment via ground.

# 9.2 Inspur Service SLA

Inspur offers a variety of Service Level Agreements (SLA)\*2 to meet customer requirements with different service components and service level targets.

- Base Warranty Services
- Advance Replacement
- 9 × 5 NBD Onsite Service
- 24 × 7 × 4 Onsite Service
- Onsite Deployment Service
- Data Media Retention
- Global Service
- Customized Service

# 9.3 Warranty Exclusions

Inspur does not guarantee that there will be no interruptions or mistakes during the use of the products. Inspur will not undertake any responsibility for the losses arising from any operation not conducted according to Inspur Hardware Products.

The Warranty Terms & Conditions do not apply to consumable parts, as well as any products that the serial number missed, damaged or obscured for the following reasons:

- Accident, misuse, abuse, defiling, improper maintenance or calibration or other external causes
- Operating beyond the parameters as stipulated in the user documentation
- Use of the software, interface, parts or supplies not provided by Inspur
- Improper staging, usage, or maintenance
- Virus infection
- Loss or damage in transit which is not arranged by Inspur
- The product has been modified or serviced by non-authorized personnel
- Any damage to or loss of any personal data, programs, or removable storage media
- The restoration or reinstallation of any data or programs except the software installed by Inspur when the product is manufactured

- Any consumable parts, such as, but not limited to, battery or protective coating that is diminished over time, unless the failure has occurred during DOA period, such failure caused by Inspur's material or workmanship
- Any cosmetic damage, such as, but not limited to, scratches, dents, broken
  plastics, metal corrosion, or mechanical damage, unless the failure has occurred
  during DOA period due to defect in Inspur's material or workmanship
- Any engineering sample, evaluation unit, or non-mass production product is not covered under warranty service
- Any solid-state drive (SSD) with the usages of which has reached its write endurance limit

In no event will Inspur be liable for any direct loss of use, interruption of business, lost profits, lost data, or indirect, special, incidental or consequential damages of any kind regardless of the form of action, whether in contract, tort (including negligence), strict liability or otherwise, even if Inspur has been advised of the possibility of such damage, and whether or not any remedy provided should fail of its essential purpose.

<sup>\*1</sup> Service Portal availability is subject to customer type and customer location. Please contact your Inspur representative to learn more.

<sup>\*2</sup> Not all SLA offerings are available at all customer locations. Some SLA offerings may be limited to geolocation and/or customer type. Please contact your Inspur representative to learn more.

# **Appendix**

# **A.1** Drive Neodymium Content Reference Table

Table A.1-1 Seagate Drive Neodymium Content Reference

Product Series Name	Neodymium Content Range		
Product Series Name	< 5 g	5 g - 25 g	> 25 g
Cimarron (2T/4T)	<b>√</b>		
Cimarron (6T/8T)		<b>√</b>	
Evans		√ .	
Kestrel	√		
MakaraBP		√	
MakaraPLUS		√	
Mobula		√	
MobulaBP		<b>√</b>	
Skybolt	√		
Tatsu		√ .	

Table A.1-2 WD Drive Neodymium Content Reference Range

	Neodymium Content Range		
Product Series Name	< 5 g	5 g - 25 g	> 25 g
Rainier	<b>√</b>		
Libra He10		√	
Leo A		√ .	
Vela-A		√ .	
Vela-AP		√	
Hs14		√	
Leo-B		√ .	

Table A.1-3 Toshiba Drive Neodymium Content Reference Range

Dradust Carios Names	Neodymium Content Range		
Product Series Name	< 5 g	5 g - 25 g	> 25 g
AL14SE-Lite	1		
AL15SE	1		
AL14SX	1		
MG04 Tomcat-R SAS		√	
MG04 Tomcat-R SATA		√	
MG04 Tomcat SATA		√	
MG06 SAS		√	
MG06 SATA		√	
MG07 SAS		√	
MG07 SATA		√	

# A.2 Acronyms and Abbreviations

#### Α

AC	Alternating Current
ACPI	Advanced Configuration and Power Management Interface
AES	Advanced Encryption Standard New Instruction Set
Al	Artificial Intelligence
AOC	Active Optical Cables
API	Application Program Interface
ARP	Address Resolution Protocol

#### В

BIOS	Basic Input Output System
вмс	Baseboard Management Controller

# C

CE	Conformite Europeenne
CLI	Command-Line Interface
CMOS	Complementary Metal-Oxide-Semiconductor Transistor
CPLD	Complex Programming Logic Device
СРИ	Central Processing Unit
CRPS	Common Redundant Power Supplies
CRU	Customer-Replaceable Unit
CSA	Canadian Standards Association
CSM	Compatibility Support Module

#### D

DC	Direct Current
DDR4	Double Date Rate 4
DHCP	Dynamic Host Configuration Protocol
DIMM	Dual-Inline-Memory-Modules
DNS	Domain Name System
DVD	Digital Video Disc

#### F

FMA	Failure Mode Analysis
FRU	Field-Replaceable Unit

FTP	File Transfer Protocol
FW	Firmware

#### G

GPU	Graphics Processing Unit
GUI	Graphical User Interface

#### Н

НВА	Host Bus Adapter
НСА	Host Channel Adapter
HDD	Hard Disk Drive
HTML	Hyper Text Markup Language
HWRAID	Hardware Redundant Arrays of Independent Drives

#### I

1/0	Input/Output
IEC	International Electrotechnical Commission
IOPS	Input/Output Operations Per Second
IP	Internet Protocol
ІРМВ	Intelligent Platform Management Bus
IPMI	Intelligent Platform Management Interface
iSCSI	Internet Small Computer System Interface

J

Joint Test Action Group
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#### K

KVM	Keyboard Video Mouse
IXVI-1	Reysourd video Flouse

#### L

LAN	Local Area Network
LCD	Liquid Crystal Display
LED	Light Emitting Diode
LRDIMM	Load Reduced Dual In-Lane Memory Module

#### М

MLAN
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#### Ν

NCSI	National Communication System Instructions
NEMA	National Electrical Manufacturers Association
NFPA	National Fire Protection Association
NIC	Network Interface Controller
NM	Node Manager
NPU	Network Processing Unit
NTP	Network Time Protocol

NVDIMM	Non-Volatile Dual In-Line Memory Module
NVMe	Non-Volatile Memory Express

#### 0

ОСР	Open Compute Project
OS	Operating System

#### Ρ

PCH	Platform Controller Hub
PCI	Peripheral Component Interconnect
PCIe	Peripheral Component Interconnect express
PDU	Power Distribution Unit
PFR	Platform Firmware Resilience
РНМ	Processor Heatsink Module
PHY	Physical
PMBus	Power Management Bus
POST	Power On Self Test
PSU	Power Supply Unit
PXE	Pre-boot Execution Environment

#### R

RAM	Random-Access Memory	
10 U-1	Random Access Memory	

RAID	Redundant Arrays of Independent Drives
RDIMM	Registered Dual In-line Memory Module
RH	Relative Humidity
ROM	Read-Only Memory
RTA	Real Time Clock

#### S

SAS	Serial Attached Small Computer System Interface
SATA	Serial Advanced Technology Attachment
SFP	Small Form-factor Pluggable
SIC	Smart Interface Card
SKU	Stock Keeping Unit
SMTP	Simple Mail Transfer Protocol
SNMP	Simple Network Management Protocol
SOL	Serial Over LAN
SSD	Solid State Disk
SSH	Secure Shell
SWRAID	Software Redundant Arrays of Independent Drives

#### Т

TCG	Trusted Computing Group
ТСМ	Trusted Cryptography Module

тсо	Total Cost of Ownership
TDP	Thermal Design Power
TPCM	Trusted Platform Control Module
ТРМ	Trusted Platform Module

# U

UEFI	Unified Extensible Firmware Interface
UID	User Identification
UPI	Ultra Path Interconnect
UPS	Uninterruptible Power Supply
USB	Universal Serial Bus

#### V

VGA	Video Graphics Array
VLAN	Virtual Local Area Network

#### X